

## CALENDAR

## Upcoming: March 27–30 NABIS Conf.; April 17–21 MRS Spring Meeting, MRS

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, B-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the November 2005 MRS BULLETIN for January 2006 Calendar entries. For updates, access www.mrs.org/meetings/other/.

## FEBRUARY 2006

4–8 ▼ IEEE Intl. Solid-State Circuits Conf. (ISSCC), *San Francisco, CA*. Diane Melton, Courtesy Associates, 2025 M. St., NW, 8th Floor, Washington, DC, 20036; 202-367-2456; fax 202-973-8722; e-mail isscc@courtesyassoc.com; www.isscc.org/isscc.

5–9 ▼ Australasian Polymer Symp. (APS2006)/Australasian Society for Biomaterials Annual Conf., *Rotorua, Australia*. Secretariat Plevin and Associates Pty Ltd, PO Box 54, Burnside 5066, Australia, 61-8-8379-8222; fax 61-8-8379-8177; e-mail events@plevin.com.au; www.plevin.com.au/28aps2006.

5–9 ▼ Laser Applications to Chemical, Security and Environmental Analysis, *Incline Village, NV*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings/topicals/LACSEA.

5–10 ▼ GRC on Colloidal, Macromolecular & Polyelectrolyte Solutions, *Ventura, CA*. Eric Kaler, University of Delaware, Colburn Laboratory, Newark, e-mail kaler@che.udel.edu; www.grc.uri.edu/programs/2006/colloid.htm.

7–9 ▼ IEEE Sensors Applications Symp., *Houston, TX*. Robert Myers, 799 North Beverly Glen, Los Angeles, 310-446-8280; fax 310-446-8390; e-mail bob.myers@ieee.org; www.sensorapps2006.org.

11–14 Association of Biomolecular Resource Facilities (ABRF) Intl. Symp.: Integrating Science, Tools, and Technologies with Systems Biology, *Long Beach, CA*. Jean Lash, FASEB/OSMC, Exhibit Manager, 9650 Rockville Pike, Bethesda, MD 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings/abrf2006.

12–16 ▼ Non-Volatile Semiconductor Memory Workshop (NVSMW), *Monterey, CA*. Richard Eguchi, Freescale Semiconductor, Inc., 6501 William Cannon Dr. West, M/S OE341, Austin, TX, 78735; 512-895-2364; fax 512-895-8605; e-mail richard.eguchi@freescale.com; www.evh.ieee.org/soc/eds/nvsmw.

14–16 ▼ Pharmaceutical Powder X-ray Diffraction Symp. (PPXRD-5), *Somerset, NJ*. Leah Mooney, International Centre for Diffraction Data, 12 Campus Blvd., Newtown Square, PA, 19073; 610-325-9814; fax 610-325-9823; e-mail ppxrd@icdd.com; www.icdd.com/ppxrd.

15–17 ▼ IASTED Intl. Conf. on Biomedical Engineering (BioMed 2006), *Innsbruck, Austria*. Secretariat IASTED, #80, 4500 16th Ave. N.W., Calgary, AB, T3B 0M6; 403-288-1195; fax 403-247-6851; e-mail calgary@iasted.org; www.iasted.org/conferences/2006/Innsbruck/c519.htm.

15–17 Smart Coatings 2006, *Orlando, FL*. Sandra Tanner, Coatings Research Institute, 430 W. Forest Ave., Ypsilanti, MI, 48197; 734-487-2203; fax 734-483-0085; e-mail sandy.tanner@emich.edu; www.emich.edu/public/coatings\_research/smartcoatings.

**16** ▼ Intl. Workshop on Biomedical Applications of Nanotechnology (NanoMed 2006), *Berlin, Germany*. Marius Köbel, CC-NanoChem, Germany, 49 681 9300-398; fax 49 681 9300-223; e-mail nanomed2006@cc-nanochem.de; www.cc-nanochem.de/nanomed2006.

**18-22** Biophysical Society Annual Meeting, *Salt Lake City, Utah*. www.biophysics.org/meetings/2006.

**19-24** SPIE—Microlithography Conference, *San Jose, CA*. SPIE Meetings, P.O. Box 10, Bellingham, WA, 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/conferences.

**20-22** ▼ IEEE / RAS-EMBS Intl. Conf. on Biomedical Robotics and Biomechatronics (BioRob 2006), *Pisa, Italy*. BioRob 2006, e-mail biorob2006@arts.sssup.it; www.biorob2006.org.

**21-22** ▼ Intl. Conf. on Rubber Bonding, *Düsseldorf, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/rubberbonding06.

**26-1** Intl. Polyolefins Conf. 2006, *Houston, TX*. Lisa Songy, Polyolefins 2005, KnightHawk Engineering, Inc., 17625 El Camino Real, Suite 412, Houston, TX 77058; 281-282-9200; e-mail lsongy@knighthawk.com; www.spe-stx.org/PolyolefinsConference.htm.

**26-2** SPIE—Smart Structures and Materials and Nondestructive Evaluation for Health Monitoring and Diagnostics, *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/Conferences/calls/06/ss.

**27-1** Intl. Conf. on Superhard Coatings, *Ein-Gedi, Israel*. E-mail hardcoat@eng.tau.ac.il; www.hardcoat.org.

**27-3** ▼ Intl. Zurich Symp. on Electromagnetic Compatibility, *Suntec City, Singapore*. Meeting Matters International, Secretariat EMC-ZURICH, 5 Toh Tuck Link, Singapore, Singapore, 65-6466-5775; fax 65-6467-5281; e-mail info@emc-zurich.org; www.emc-zurich.org.

## MARCH 2006

**5-7** World Steel Conf., *Barcelona, Spain*. Marilyn Portner, CRU Events, 31 Mount Pleasant, London WC1X 0AD, London, United Kingdom; 44-20-7903-2402; e-mail cruevents@crugroup.com; www.cruevents.com.

**5-10** ▼ OFC/NFOEC Conf. and Exposition, *Anaheim, CA*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.ofcnfoec.org.

**6-8** ▼ 7th Intl. Conf. on Microelectronics and Interfaces (ICMI), *Austin, TX*. American Vacuum Society, AVS, 110 Yellowstone Drive, Suite 120, Chico, CA, 95973; 530-896-0477; fax 530-896-0487; e-mail della@avs.org; www.icmiconference.org.

**6-9** ▼ IEEE Intl. Conf. on Microelectronic Test Structures (ICMETS), *Austin, TX*. Wendy Walker, 16220 So. Frederick Ave., Suite 312, Gaithersburg, MD, 20877; 301-527-0900ext104; fax 301-527-0994; e-mail wendyw@widerkehr.com; www.see.ed.ac.uk/ICMETS.

**12-14** ▼ Intl. Conf. on Applications of Electrical Engineering (AEE 06), *Prague, Czech Republic*. World Scientific and Engineering Academy and Society, WSEAS, 6842 Main Street, Miami Lakes, 1-800-24-SHULA; e-mail info@wseas.org; www.worldses.org/conferences/2006/prague/ae/index.html.

**12-14** ▼ Intl. Conf. on Microelectronics, Nanoelectronics and Optoelectronics (MINO 06), *Prague, Czech Republic*. World Scientific and Engineering Academy and Society, WSEAS, 6842 Main Street, Miami Lakes, 1-800-24-SHULA; e-mail info@wseas.org; www.worldses.org/conferences/2006/prague/mino.

**12-16** 2006 TMS Annual Meeting and Exhibition, *San Antonio, TX*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgsv@tms.org; www.tms.org/meetings/meetings.asp.

**13-15** Phosphor Global Summit 2006, *San Diego, CA*. Stephanie Edwards, Intertech USA, Conference Director, 19 Northbrook Office Park, Portland, ME 04105; 207-781-9605; fax 207-781-2150; e-mail sedwards@intertechusa.com; www.intertechusa.com/phosphors.html.

**13-17** 2006 APS March Meeting, *Baltimore, MD*. E-mail meetings@aps.org; www.aps.org/meet.

**17-18** SPE—European Thermofforming Conf., *Salzburg, Austria*. SPE—Europe, Belgium; 32-0-3-541-77-55; fax 32-0-3-541-84-25; e-mail spe.europe@pi.be; www.4spe.org/conf/0603eutherm.php.

**19-23** ▼ Biomedical Optics Topical Meeting and Tabletop Exhibit, *Fort Lauderdale, FL*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings/topicals/BIOMED.

**20-22** Intl. Conf. on Powder Injection Molding of Metals, Ceramics and Carbides, *Tampa, FL*. Innovative Material Solutions (IMS), 605 Severn Drive, State College, PA 16803; 814-867-1140; fax 814-867-2813; e-mail info@imspowder.com; www.imspowder.com/conference.

**20-23** ▼ Intl. Conf. and Exhibition on Device Packaging, *Scottsdale, AZ*. IMAPS, 611 2nd Street N.E., Washington, DC, 20002; 202-548-4001; fax 202-548-6115; e-mail imaps@imaps.org; www.imaps.org/devicepackaging.

**21-22** ▼ Intl. Conf. on High Performance Fillers, *Cologne, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/hpfillers06.

**26-30** ACS National Meeting, *Atlanta, GA*. R. Nagarajan, Penn State University, Department of Chemical Engineering, University Park, PA 16802; 814-863-1973; fax 814-865-7846; e-mail rxn@psu.edu; membership.acs.org/c/coll/Atlanta2006.html.

**27-29** Intl. Conf. and Forum of the Society for Advancement of Material and Process Engineering (SAMPE), *Paris, France*. Klaus Drechsler, IFB Institut, Universität Stuttgart, Pfaffenwaldring 31, D-70550 Stuttgart, Germany; 49-0-711-685-2411; fax 49-0-711-685-2449; e-mail drechsler@ifb.uni-stuttgart.de; www.sampe-europe.org.

**27-30** NABIS Conf., *Chicago, IL*. Nabis Headquarters, 7000 W. Southwest Highway, Chicago Ridge, IL 60415; 708-361-6000; fax 708-361-6166; info@nabisconference.com; www.nabisconference.com/2006.

**29-30** ▼ Oilfield Engineering with Polymers 2006, *London, United Kingdom*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/oilfieldengineering06.

## APRIL 2006

**1-2** ▼ Northeast Bioengineering Conf., *Easton, PA*. Lafayette College, Ismail Jouny, Acopian Engineering Center, Easton, PA, 18042; 610-330-5414; fax 610-330-5059; e-mail jounyi@lafayette.edu; ww2.lafayette.edu/~nbec2006.

**1-5** ▼ Experimental Biology 2006 Annual Meeting, *San Francisco, CA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings/eb2006.

**2-4** ▼ Small Fuel Cells for Portable Applications, *Washington, DC*. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

**3-5** Pacific Intl. Conf. on Applications of Lasers and Optics (PICALO 2006), *Melbourne, Australia*. Laser Institute of America, 13501 Ingenuity Drive, Suite 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.laserinstitute.org/conferences/picalo.

**3-7** SPIE—Photonics Europe 2006, *Strasbourg, France*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/conferences/calls/06/epe.

**4-6** ▼ World Copper Conf., *Santiago, Chile*. Marilyn Portner, CRU Events, 31 Mount Pleasant, London WC1X 0AD, London, United Kingdom, 44-20-7903-2402; e-mail cruevents@crugroup.com; www.cruevents.com.

**5-7** Materials Congress 2006, *London, UK*. Lisa Bromley, IOM Communications, 1 Carlton House, London, SW1Y 5DB, UK; 44-20-7451-7302; fax 44-20-7839-2289; e-mail lisa.bromley@iom3.org; www.iom3.org/congress.

**6-9** IEEE Intl. Symp. on Biomedical Imaging: From Nano to Macro, *Arlington, VA*. Jelena Kovacevic, Carnegie Mellon University, Dept. of Biomedical Engineering, 5000 Forbes Avenue, Pittsburgh, PA 15213; e-mail jelenak@cmu.edu; www.biomedicalimaging.org.

**9-14** ▼ Frontiers in Boundary Lubricating Films, *Lyon, France*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6al.html.

**10-13** ▼ Intl. Conf. on Deformation, Yield and Fracture of Polymers (DYFP2006), *Rolduc Abbey, Netherlands*. Marleen Rieken, Eindhoven University of Technology, P.O. Box 513, NL-5600 MB Eindhoven, Eindhoven, Netherlands, 31-40-2472851; fax 31-40-2447355; e-mail DYFP2006@tue.nl; www.dyfp2006.tue.nl.

**17-20** ▼ Intl. Society of Electrochemistry (ISE) Spring Meeting 2006, *Singapore*. Secretariat ISE Spring 2006 Conference, 1122A Serangoon Road, Singapore, 65-6295-5790; fax 65-6295-5790; e-mail secretariat@ise2006.org; www.ise2006.org.

**17-21** 2006 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

**22-27** 49th SVC Annual Technical Conf., *Washington, D.C.* Society of Vacuum Coaters; 505-856-7188; e-mail svcinfo@svc.org; www.svc.org.

**23-27** AIChE 2006 Spring National Meeting, *Orlando, FL*. American Institute of Chemical Engineers, 3 Park Avenue, New York, NY 10016-5991; 212-591-7338; fax 212-5918894; e-mail meetmail@aiche.org; aiche.confex.com/aiche/s06/cfp.epl.

**23-27** World Congress on Particle Technology (WCPT5), *Lake Buena Vista, FL*. George Klinzing, University of Pittsburgh, Office of the Provost, 826 Cathedral of Learning, Pittsburgh, PA 15260; 412-624-0784; fax 412-624-4618; e-mail confchair@wcpt5.org; www.erpt.org/wcpt5.

**23-28** ▼ Intl. Conf. on Mechanics and Mechanical Properties of Non-crystalline Materials I: Amorphous Metals, *Beijing, China*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6am.html.

**24-26** Intl. Brazing and Soldering Conf. (IBSC) *San Antonio, TX*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org; www.asminternational.org/ibsc.

**24-28** ▼ Integrated Photonics Research and Applications Topical Meeting (IPRA) and Nanophotonics Topical Meeting (NP), *Uncasville, CT*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings/topicals/ipr\_np.

MAY 2006

25-26 ▼ Joining Plastics 2006, London, United Kingdom. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/JoiningPlastics06.

25-27 IMAPS/ACerS Intl. Conf. and Exhibition on Ceramic Interconnect and Ceramic Microsystems Technologies (CICMT), Denver, CO. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; www.cicmt.org.

26-29 ▼ SFB 2006—Society for Biomaterials Annual Meeting and Exposition, Pittsburgh, PA. Rebecca Hanes, Society for Biomaterials, 17000 Commerce Parkway, Suite, Mt. Laurel, 856-439-0826 x3061; fax 856-439-0525; e-mail rhaines@ahint.com; www.biomaterials.org/Meetings/06AnnualMeeting.

3-6 Intl. Conf. on High Performance Structures and Materials, Ostend, Belgium. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/hpsm06.

7-11 Intl. Conf. on Shape Memory and Superelastic Technologies (SMST), Pacific Grove, CA. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org; www.asmiinternational.org/shape.

7-11 ▼ Nanotech 2006/Bio Nano 2006, Boston, MA. Sarah Wenning, 696 San Ramon Valley Blvd., Ste. 423, Danville, 925-901-4959; fax 925-886-8461; e-mail wenning@nsti.org; www.nsti.org/Nanotech2006.

7-11 SPE—Annual Technical Conference (ANTEC), Charlotte, NC. Society of Plastics Engineers, SPE—Europe, Belgium; 32-0-3-541-77-55; fax 32-0-3-541-84-25; e-mail spe.europe@pi.be; www.speurope.org.

7-12 ▼ Intl. Symp. on Dielectrics for Nanosystems: Materials Science, Processing, Reliability, and Manufacturing II, Denver, CO. Durgamadhab Misra, New Jersey Institute of Tech., 161 Warren St., Newark, 973-596-5739; fax 973-596-5680; e-mail dmisra@njit.edu; www.electrochem.org/meetings/future/209/meeting.htm.

7-12 ▼ World Conf. on Photovoltaic Energy Conversion, Waikoloa, HI. Sheila Bailey, NASA Glenn Research Center, Cleveland, 216-433-2228; fax 216-433-6106; e-mail sheila.g.bailey@nasa.gov; www.meetingassistant.com/PVSC/worldconference.php.

8-10 Intl. Conf. on Advances in Fluid Mechanics, Skiathos, Greece. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/afm06.

8-11 ▼ IEEE Intl. Conf on Indium Phosphide and Related Materials (IPRM), Princeton, NJ. IEEE/LEOS, 445 Hoes Lane, PO Box 1331, Piscataway, NJ, 08855; 732-562-3899; fax 732-562-8434; e-mail leosconferences@ieee.org; www.i-leos.org.

13-16 Particles 2006—Medical/Biochemical Diagnostic, Pharmaceutical, and Drug Delivery Applications of Particle Technology, Orlando, FL. Particles 2006, 265 Clover Street, Rochester, NY 14610-2246; 585-288-5913; fax 585-482-7795; e-mail info@nanoparticles.org; nanoparticles.org/Particles2006.

14-17 ▼ Intl. Pharmaceutical Industry Conf., Edinburgh, United Kingdom. Laura Milne, SCI 14/15 Belgrave Square, London, United Kingdom, 44-0-20-7598-1565; fax 44-0-20-7235-7743; e-mail laura.milne@soci.org; www.soci.org/SCI/SClpharm/html/home.jsp.

14-19 ▼ Intl. Fatigue Congress (Fatigue 2006), Atlanta, GA. Nina Woods, Elsevier, The Boulevard, Langford Lane, Kidlington, Oxford, United Kingdom, 44-0-1865-843297; fax 44-0-1865-843958; e-mail n.woods@elsevier.com; www.fatigue2006.com.

15-17 Intl. Surface Engineering Congress, Seattle, WA. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org.

15-17 Intl. Thermal Spray Conf. and Exposition, Seattle, WA. International ASM, 9639 Kinsman Rd., Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; e-mail Cust-srv@asminternational.org; www.asmiinternational.org/itsc.



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**15-18** AeroMat Conf. & Exposition, *Seattle, WA*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org.

**15-18** ICNDST & ADC 2006 Joint Conf., *Research Triangle Park, NC*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**

**15-20** Intl. Symp. on Functional Pi-Electron Systems, *Osaka, Japan*. Kenichi Nakayama, Osaka University, 2-1 Yamadaoka, Suita, Osaka, Japan, e-mail nakayama@mls.eng.osaka-u.ac.jp; www-molsys.mls.eng.osaka-u.ac.jp/fpi7.

**16-17** Blowing Agents and Foaming Processes 2006, *Munich, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/blowingagents06.

**16-19** Glass and Optical Materials Meeting, *Greenville, SC*. American Ceramic Society, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; ceramics.org/meetings/gomd06.

**17-19** Intl. Symp. Interface Biology of Implants, *Rostock, Germany*. Joachim Rychly, Universität Rostock, Ernst-Heydemann-Str. 6, 18057 Rostock, Rostock, Germany, 49-0-381-494-7773; fax 49-0-381-494-5730; e-mail joachim.rychly@med.uni-rostock.de; www.uni-rostock.de/ibi.

**21-26** Conf. on Lasers and Electro-Optics - Quantum Electronics and Laser Science (CLEO/QELS), *Long Beach, CA*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.cleoconference.org.

**21-26** Polymer Reaction Engineering, *Halifax, NS*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6ab.html.

**22-25** Intl. Symp. on Colloidal and Molecular Electrooptics (ELOPTO-2006), *Kyoto, Japan*. Tsuneo Okubo, Yamagata University, Cooperative Research Center, Johan 4-3-16 Yonezawa 992-8510 Japan; 81-238-26-3602; fax 81-238-26-3409; e-mail okubo@yz.yamagata-u.ac.jp; www.elopto.jp.

**22-26** ICMOVPE XIII—Intl. Conf. on Metal-Organic Vapor Phase Epitaxy, *Miyazaki, Japan*. Yoshinao Kumagai, Tokyo University of A & T, Koganei, Tokyo 184-8588, Japan; 81-42-388-7469; fax 81-42-386-3003; e-mail icmovpe@cctuat.ac.jp; icmovpe13.chem.tuat.ac.jp.

**23-27** Seminar and Meeting on Ceramics, Cells and Tissues: Materials for Scaffolding of Biologically Engineered Systems, *Faenza, Italy*. Rossella Ravaglioli, ISTE-CNR, Via Granarolo, 64-48018, Faenza, Ravenna, Italy, 39-0546-670-311; fax 39-0546-670-399; e-mail 10cct@agenziapolceramico.it; www.istec.cnr.it.

**24-26** Intl. Conf. Comparing Design in Nature with Science and Engineering, *The New Forest, UK*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/design06.

**24-27** Intl. Conf. on Perspective Technologies and Methods in MEMS Design (MEMSTECH), *Lviv, Ukraine*. Mykola Pereyma, Lviv Polytechnic National University, St. Bandera 12, 79013, Lviv, Ukraine, 38-0322-72-29-72; fax 38-0322-72-29-72; e-mail memstech@polynet.lviv.ua; www.lp.edu.ua/Institute/IKN/CAD/MEMSTECH.

**26** IEEE/LEOS Semiconductor Laser Workshop, *Long Beach, CA*. IEEE/LEOS, 445 Hoes Lane, PO Box 1331, Piscataway, NJ, 08855; 732-562-3899; fax 732-562-8434; e-mail leosconferences@ieee.org; www.i-leos.org.

**28-1** Intl. Symp. on Macro- and Supramolecular Architectures and Materials (MAM-06): Practical Nano-Chemistry and Novel Approaches, *Tokyo, Japan*. Waseda University, Symposium MAM-06, Tokyo, Japan, 81-3-3200-2669; fax 81-3-3209-5522; e-mail MAM-06@mse.waseda.ac.jp; www.waseda.jp/assoc-MAM-06.

**28-2** MCWASP—Modeling of Casting, Welding and Advanced Solidification Processes Conference, *Opio, France*. ESA Conference Bureau/Congrex Holland BV, MCWASP, P.O. Box 299, AG Noordwijk, Netherlands; 31-71-565-5005; fax 31-71-565-5658; e-mail Esa.Conference.Bureau@esa.int; www.mcwasp.org.

**29-2** E-MRS-IUMRS-ICEM 06, *Nice, France*. P. Siffert, E-MRS 2006 Spring Meeting, BP 20, 67037 Strasbourg Cedex 2, France; 33-3-88-10-65-43; fax 33-3-88-10-63-43; e-mail emrs@phase.c-strasbourg.fr; www-emrs.c-strasbourg.fr/2006\_SPRING/2006\_meeting.htm. **IUMRS; E-MRS.**

**29-2** Structure and Mechanical Properties of Nanostructured Materials, *Beijing, P.R. China*. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6au.html.

## JUNE 2006

**3-8** IEEE Intl. Conf. on Plasma Sciences (ICOPS), *Acme, MI*. Claire Rosser, Michigan State University, Rm. B100 RCE, East Lansing, MI, 48824; 517-432-8711; fax 517-432-8714; e-mail mrosser@egr.msu.edu; www.icops2006.org.

**4-9** Intl. Conf. on Modern Materials Science and Technology (CIMTEC), *Acireale, Italy*. Corso Mazzini, CIMTEC, 52—P.O. Box 174 48018, Faenza, Italy; 39-546-22461; fax 39-546-664138 e-mail congress@technagroup.it; www.cimtec-congress.org.

**5-8** 2nd Intl. FIB Congress 2006 (Intl. Federation for Structural Concrete), *Naples, Italy*. Secretariat FIB Congress, University of Naples Federico II, via Claudio, 21 - 80125, Naples, Italy, e-mail fib2006@unina.it; www.naples2006.com.

**6-7** Medical Polymers 2006, *Cologne, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/medicalpolymers06.

**6-8** Magneto-Optical Recording Intl. Symp. 2006 (MORIS 2006) Workshop, *Chiba Prefecture, Japan*. MORIS 2006 Workshop Secretariat, Proactive Inc., Promena Kobe 16F, 1-8-1, Higashikawasaki-cho, Chuo-ku, Kobe 650-0044, Japan; 81-78-366-5050; fax 81-78-366-5051; moris2006ws@pac.ne.jp; www.ecs.cst.nihon-u.ac.jp/moris2006ws. **Endorsed.**

**8-10** IEEE Intl. Symp. on Technology and Society (ISTAS), *Queens, NY*. Clinton Andrews, Rutgers University, 33 Livingston Ave. #302, New Brunswick, NJ, 08901; 732-932-3822 ext721; fax 732-932-2253; e-mail c.j.andrews@ieee.org; www.ieeessit.org.

**11-15** Advanced Membrane Technology III: Membrane Engineering for Process Intensification, *Cetraro, Italy*. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6aj.html.

**11-15** Intl. Conf. on Transport Phenomena in Micro and Nanodevices, *Barga, Italy*. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6at.html.

**12-14** Intl. Conf. Advances in Fusion and Processing of Glass, *Dresden, Germany*. German Society of Glass Technology (DGG), Siemensstrasse 45, 63071 Offenbach, Germany; 49-0-69-975861-0; fax 49-0-69-975861-99; e-mail dgg@hvg-dgg.de; www.hvg-dgg.de/de/8th\_international\_conference.htm.

**12-15** Microwave Materials and their Applications, *Oulu, Finland*. MMA 2006. Microelectronics and Materials Physics Laboratories, Dept. of Electrical Engineering, University of Oulu, Linnanmaa, FIN-90570 Oulu, Finland; mma2006@ee.oulu.fi; www.ee.oulu.fi/research/miklab/mma2006.

**13-16** Northern Optics (NO2006), *Bergen, Norway*. Gerd Pettersen, Instituttvegen 25, PO Box 70, NO-2027 Kjeller, Norway, 47-6484-4703; fax 47-6381-8146; e-mail gerd@unik.no; web.unik.no/NO2006.

**18-21** ACS Colloid and Surface Science Symp., *Boulder, CO*. Daniel Schwartz, University of Colorado, Dept. of Chemical Engineering, Boulder, CO 80309-0424; 303-735-0240; fax 303-492-4341; e-mail daniel.schwartz@colorado.edu; www.colloid.org.

**21-25** ASME 2006 Summer Bioengineering Conf., *Amelia Island, FL*. Barry Lieber, University of Miami, Biomedical Engineering, Rm 203 McArthur Annex, 1251 Memorial Drive, Coral Gables, FL 33146; e-mail blieber@miami.edu; divisions.asme.org/bed/events/summer06.html.

**24-30** Beijing Intl. Materials Week, *Beijing, China*. Lin Jianyun, Room 4102, 62 Zizhuyuan Road, Beijing, Peoples Republic of China, 86-10-68722031; fax 86-10-68722033; e-mail 2006BIMW@sohu.net; www.c-mrs.org.cn/huiyi\_list.asp. **C-MRS.**

**25-29** Intl. Congress on Ceramics, *Toronto, Canada*. American Chemical Society, 1155 Sixteenth Street NW, Washington, DC, 20036; 202-872-4374; fax 202-872-6128; e-mail natlmtgs@acs.org; www.ceramics.org.

**25-30** Novel and Emerging Ceramics and Composites, *Kona Coast, HI*. ECI 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6afbody.html.

**26-28** IASTED Intl. Conf. on Applied Simulation and Modelling, *Rhodes, Greece*. Secretariat IASTED, #80, 4500 16th Ave. N.W., Calgary, AB, T3B 0M6; 403-288-1195; fax 403-247-6851; e-mail calgary@iasted.org; www.iasted.org/conferences/2006/Greece/c522.htm.

**26-29** ECM VII: Cartilage & Joint Repair, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournals.org/ecm\_meetings/ecm7.

**26-29** Intl. Energy Conversion Engineering Conf. (IECEC 2006), *San Diego, CA*. Michael Piszczor, NASA Glenn Research Center, Cleveland, OH, 44135; 216-433-2237; e-mail michael.piszczor@grc.nasa.gov; www.iaaa.org/events/iecec.

**26-30** IEEE Intl. Conf. on Properties and Applications of Dielectric Materials (ICPADM), *Bali, Indonesia*. Dr. Suwarno, Bandung Institute of Technology, Jl. Ganesha 10, Bandung, Indonesia, 62-22-250-2260; fax 62-22-253-4222; e-mail suwarno@ieee.org; www.icpdm2006.com.

**30-4** Intl. Conf. on Nanoscience and Technology ICN&T 2006, *Basel, Switzerland*. ICN&T 2006, c/o AKM Congress Service, Clarastrasse 57, CH-4005 Basel, Switzerland; 41-61-686-77-11; fax 41-61-686-77-88; e-mail info@akm.ch; www.icnt2006.ch.

## JULY 2006

**2-6** European Conf. on Foams, Emulsions and Applications (EUFOAM 2006), *Potsdam, Germany*. Reinhard Miller, Max Planck Institut Colloids and Interfaces, Am Muelenberg 1, D-14476 Potsdam-Golm, Germany; 49-331-567-9252; fax 49-331-567-9202; e-mail eufoam2006@mpikg.mpg.de; www.mpiikg.mpg.de/en/gf/eufoam2006.

**2-7** 21st International Liquid Crystal Conference, *Keystone, CO*. Kinsley & Associates, Conference Management Office, LLC, 303-798-3664; ilcc@kinsleyassociates.com; www.ilcc2006.com.

**9-12** Fractography of Glasses and Ceramics V, *Rochester, NY*. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; engineering.alfred.edu/outreach/conf/fractography.

**9-12** Intl. Symp. on New Materials for Electrochemical Systems, *Montréal, Canada*. Secretariat New Materials 2006, Bureau des Congrès Universitaires, 6600 Côte-des-Neiges Road, Suite 510, Montreal, Quebec, H3S 2A9 Canada; 514-340-3215; fax 514-340-4440; e-mail newmat@congressbcu.com; newmaterials.congressbcu.com.

**9-13** ▼ Structure and Dynamics of Self-Organized Macromolecular Systems, Prague, *Czech Republic*. Petr Štěpánek, Institute of Macromolecular Chemistry, Heyrovského nám. 2, CZ-162 06 Praha 6, Praha, Czech Republic, 420-296-809-332; fax 420-296-809-410; e-mail [sympo@imc.cas.cz](mailto:sympo@imc.cas.cz); www.imc.cas.cz/sympo/45micros.html.

**16-20** ▼ IEEE Conf. on Nanotechnology (IEEE-NANO), Cincinnati, OH. Clifford Lau, Institute for Defense Analysis, 4850 Mark Center Drive, Alexandria, VA, 22311; 703-933-6525; fax 703-845-6848; e-mail [clau@ida.org](mailto:clau@ida.org); www.ececs.uc.edu/~mcahay/Nano2006/index2006.html.

**16-22** ▼ World Congress on Computational Mechanics, Los Angeles, CA. WCCM 2006, e-mail [wccm2006@seas.ucla.edu](mailto:wccm2006@seas.ucla.edu); www.wccm2006.northwestern.edu.

**22-26** Annual Meeting and Exposition of the Controlled Release Society, Vienna, Austria. Controlled Release Society, 3650 Annapolis Lane North, Suite 107, Minneapolis, MN 55447-5434; 763-512-0909; fax 763-765-2329, e-mail [meetings@controlledrelease.org](mailto:meetings@controlledrelease.org); www.controlledrelease.org.

**30-2** ▼ Fifth Intl. Conf. on Synchrotron Radiation in Materials Science, Chicago, IL. www.aps.anl.gov/News/Conferences/2006/SRMS/.

**30-2** IEEE Intl. Symp. on Applications of Ferroelectrics, Sunset Beach, NC. Jon-Paul Maria, 1001 Capability Drive, Research Building One, Office 322, Raleigh, NC 27606; 919-513-2843; fax 919-515-3419; e-mail [jpmaria@ncsu.edu](mailto:jpmaria@ncsu.edu); www.ieee-uffc.org.

**31-4** ▼ Intl. Conf. on Ultrafast Phenomena, Pacific Grove, CA. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail [info@osa.org](mailto:info@osa.org); www.osa.org/meetings/topicals/ulp.

## AUGUST 2006

**5-9** ▼ Symp. of The Protein Society, San Diego, CA. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail [jlash@faseb.org](mailto:jlash@faseb.org); www.faseb.org/meetings.

**6-10** IMS Annual Convention, Chicago, IL. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org; www.asminternational.com.

**6-10** Microscopy and Microanalysis 2006, Chicago, IL. Microscopy/Marketing & Education, Inc., Microscopy & Microanalysis Meeting Management, 125 Parido Street, Suite 102, Springfield, MA, 01118-2130; 972-954-8011; fax 972-954-8018; e-mail [corporate@mme1.com](mailto:corporate@mme1.com); [microscopy.org/MMMeetings](http://microscopy.org/MMMeetings).

**13-17** SPIE—Optics and Photonics, San Diego, CA. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [spie.org/app/conferences](http://spie.org/app/conferences).

**14-18** ▼ IEEE Intl. Symp. on Electromagnetic Compatibility (EMC 2006), Portland, OR. Vita Feuerstein, IEEE, 445 Hoes Lane, Piscataway, 732-562-6826; fax 732-981-1203; e-mail [vita@ieee.org](mailto:vita@ieee.org); www.emc2006.org.

**19-23** ▼ ACS National Meeting & Exposition, Boston, MA. National Expositions American Chemical Society, 1155 Sixteenth Street, Washington, DC, 20036; e-mail [expo@acs.org](mailto:expo@acs.org); www.chemistry.org/expositions.

**19-25** ▼ World Renewable Energy Congress and Exhibition, Florence, Italy. Ali Sayigh, PO Box 362, Brighton BN2 1YH, United Kingdom, 44-1273-625-643; fax 44-1273-625-768; e-mail [asayigh@netcomuk.co.uk](mailto:asayigh@netcomuk.co.uk); www.wrenuk.co.uk/wrecix.html.

**20-25** ▼ Intl. Conf. on the Application of Accelerators in Research and Industry, Fort Worth, TX. Margaret Hall, University of North Texas, PO Box 311427, Denton, TX, 76203-1427; 940-565-3250; fax 940-565-2227; e-mail [caari2006@unt.edu](mailto:caari2006@unt.edu); www.caari2006.com.

**20-25** NANO-2006—Intl. Conf. on Nanostructured Materials, Bangalore, India. Prof. K. Chattopadhyay, Dept. of Metallurgy, Indian Institute of Science, Bangalore 560 012, India; 91-80-22932262; fax 91-80-23601991; e-mail [nano2006@met.iisc.ernet.in](mailto:nano2006@met.iisc.ernet.in); [met.iisc.ernet.in/~nano2006](mailto:met.iisc.ernet.in/~nano2006).

**21-24** ▼ IEEE/LEOS Intl. Conf. on Optical MEMs and Their Applications (MOEMS), Big Sky, MT. IEEE/LEOS, 445 Hoes Lane, PO Box 1331, Piscataway, NJ, 08855; 732-562-3899; fax 732-562-8434; e-mail [leosconferences@ieee.org](mailto:leosconferences@ieee.org); www.i-leos.org.

**26-27** GIA Gemological Research Conf., San Diego, CA. GIA, 5345 Armada Drive, Carlsbad, CA 92008-4602; 760-603-4019; fax 760-603-4021; e-mail [gemconference@gia.edu](mailto:gemconference@gia.edu); www.gia.edu/newsroom/608/21821/news\_release\_details.cfm.

**27-31** TMS—Sohn Intl. Symp. on Advanced Materials: Principles, Technologies, and Industrial Practice, San Diego, CA. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail [mtgserve@tms.org](mailto:mtgserve@tms.org); www.tms.org/Meetings/Specialty/FallExt2006/FallExt2006-Home.html. **Endorsed.**

**27-1** ▼ World Congress on Medical Physics and Biomedical Engineering (WC 2006), Seoul, South Korea. Secretariat WC 2006, SL Gangnam, PO Box 305, Seoul, Korea (South), 82-2-3476-7700; fax 82-2-3476-8800; e-mail [wc2006@kocconex.com](mailto:wc2006@kocconex.com); www.wc2006-seoul.org.

**30-3** ▼ Intl. Conf. of the IEEE Engineering in Medicine and Biology Society, New York, NY. Jodi Strock, IEEE/EMBS, 445 Hoes Lane, Piscataway, 732-562-3451; fax 732-981-1769; e-mail [j.strock@ieee.org](mailto:j.strock@ieee.org); www.ieee.org.

## SEPTEMBER 2006

**3-7** ▼ Polymer Networks Group Conf. 2006—Functional and Biological gels and networks: theory and experiment, Sheffield, United Kingdom. Shelagh Cowley, University of Sheffield, Dainton Building, Brook Hill, Sheffield, United Kingdom, 44-0-114-222-9537; fax 44-0-114-222-9389; e-mail [s.h.cowley@sheffield.ac.uk](mailto:s.h.cowley@sheffield.ac.uk); www.polymernetworks.group.shef.ac.uk.

**5-8** ▼ European Conf. on Computational Fluid Dynamics (ECCOMAS CFD 2006), Egmond aan Zee, Netherlands. Secretariat ECCOMAS CFD 2006, Delft University of Technology, Mekelweg 4, 2628 CD Delft, Delft, Netherlands, 31-0-6-27227520; fax 31-0-10-5112119; e-mail [eccomascf2006@math.tudelft.nl](mailto:eccomascf2006@math.tudelft.nl); www.eccomascf2006.nl.

**6-8** ▼ Intl. Conf. on the Characterization and Control of Interfaces (ICCCI 2006), Kurashiki, Japan. Makio Naito, Osaka University, 11-1, Mihogaoka, Ibaraki, Osaka, Japan, 81-6-6879-8660; fax 81-6-6879-8680; e-mail [m-naito@jwri.osaka-u.ac.jp](mailto:m-naito@jwri.osaka-u.ac.jp); www.jwri.osaka-u.ac.jp/%7EIconf/icc2006/index.html.

**10-14** ACS National Meeting and Exposition, San Francisco, CA. American Chemical Society, attn: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; [expo@acs.org](mailto:expo@acs.org); [chemistry.org/expositions](http://chemistry.org/expositions).

**10-15** ESOMAT—European Symp. on Martensitic Transformations, Bochum, Germany. ESOMAT; e-mail [esomat06@ruhr-uni-bochum.de](mailto:esomat06@ruhr-uni-bochum.de); www.ruhr-uni-bochum.de/esomat06.

**12-15** ▼ Intl. Conf. on Computational Structures Technology (CST 2006), Las Palmas de Gran Canaria, Spain. Dun Eaglais, Civil-Comp Limited, Station Brae, Kippen, Stirling, United Kingdom, 44-0-1786-870-166; fax 44-0-1786-870-167; e-mail [info@civil-comp.com](mailto:info@civil-comp.com); www.civil-comp.com/conf/cst2006.htm.

**12-15** ▼ Intl. Conf. on Engineering Computational Technology (ECT 2006), Las Palmas de Gran Canaria, Spain. Dun Eaglais, Civil-Comp Limited, Station Brae, Kippen, Stirling, United Kingdom, 44-0-1786-870-166; fax 44-0-1786-870-167; e-mail [info@civil-comp.com](mailto:info@civil-comp.com); www.civil-comp.com/conf/ect2006.htm.

**13-15** ▼ European Conf. on Residual Stresses (ECRS 7), Berlin, Germany. Walter Reimers, Technical University Berlin, Sekr BH-18, Ernst-Reuter-Platz 1, Berlin, Germany, 49-0-30-314-22417; fax 49-0-30-314-22996; e-mail [Walter.Reimers@TU-Berlin.de](mailto:Walter.Reimers@TU-Berlin.de); www.tu-berlin.de/fak3/wewi/metallische\_werkstoffe/ecrs7.

**17-22** ▼ Workshop on Non Equilibrium Phenomena in Supercooled Fluids, Glasses and Amorphous Materials, Pisa, Italy. Laura Andreozzi, Università di Pisa, Largo Pontecorvo n.3, I-56127, Pisa, Italy, 39-050-2214891; fax 39-050-2214890; e-mail [workshop4@df.unipi.it](mailto:workshop4@df.unipi.it); wneq4.df.unipi.it.

**18-22** Intl. Conf. on the Structure of Non-Crystalline Materials, Praha, Czech Republic. Romana Kocova, Icaris Conference Management, m. Dr. Holého 8, 180 00 Praha 8—Liben, Czech Republic; 420-284-823-250; fax 420-266-312-113; e-mail [romana@icaris.cz](mailto:romana@icaris.cz); www.icaris.info/NCM10.

**19-20** ▼ Silicone Elastomers 2006, Frankfurt, Germany. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail [conferences@rapra.net](mailto:conferences@rapra.net); www.rapra.net/conferences/siliconeelastomers06.

**24-26** ▼ Crystallization 2006, Jackson Hole, WY. American Ceramic Society, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail [info@ceramics.org](mailto:info@ceramics.org); www.ceramics.org/meetings/crystallization.

**24-28** Intl. Symp. on Crystallization in Glasses and Liquids, Jackson Hole, WY. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail [info@ceramics.org](mailto:info@ceramics.org); www.ceramics.org/meetings/crystallization.

**24-29** ▼ Intl. Congress on Solid State Chemistry (SSC 2006), Pardubice, Czech Republic. Tomas Wagner, University of Pardubice, Legions Sq. 565, 532 10, Pardubice, Czech Republic, 420-466-037-144; fax 420-466-037-311; e-mail [ssc@upce.cz](mailto:ssc@upce.cz); [www.upce.cz](http://www.upce.cz).

**24-29** ▼ Process Intensification and Process Innovation—(PI)2 II Cleaner, Sustainable, Efficient Technologies for the Future, Christchurch, New Zealand. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail [info@eci.poly.edu](mailto:info@eci.poly.edu); www.engconfintl.org/6ap.html.

## OCTOBER 2006

**1-5** ▼ Metabolic Engineering VI: From recDNA towards Engineering Biological Systems, Noordwijkerhout, Netherlands. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail [info@eci.poly.edu](mailto:info@eci.poly.edu); www.engconfintl.org/6ay.html.

**3-6** World Congress on Emulsions, Lyon, France. 140 cours Charlemagne, 69002 Lyon, France; 33-0-4-72-77-45-50; fax 33-0-4-72-77-45-77; e-mail [cme@package.fr](mailto:cme@package.fr); www.cme-emulsion.com.

**4-6** ▼ Knowledge Foundation TCA Summit 2006—Innovations in Materials Science for Technology Commercialization, Washington, DC. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; 617-232-7400; fax 617-232-9171; e-mail [custserv@knowledgefoundation.com](mailto:custserv@knowledgefoundation.com); www.knowledgefoundation.com.

**5-7** ACS Northeast Regional Meeting, Binghamton, NY. Beverly Johnson, American Chemical Society, Regional Meetings, 1155 Sixteenth Street, Washington, DC 20036; 202-872-6264; e-mail [b\\_johnson@acs.org](mailto:b_johnson@acs.org). **Endorsed.**

**10-14** ▼ Biomedical Engineering Society 2006 Annual Fall Meeting, Chicago, IL. Biomedical Engineering Society, 8401 Corporate Drive, Suite 225, Landover, MD, 20785-2224; 301-459-1999; fax 301-459-2444; e-mail [info@bmes.org](mailto:info@bmes.org); www.bmes.org/meetings.asp.

**16-19** Material Science and Technology Conf. and Exhibition (MS&T06), Cincinnati, OH. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail [info@ceramics.org](mailto:info@ceramics.org); www.ceramics.org/meetings.

**17-18** ▼ **Plastics Additives and Compounding Conf.** (Addcon World 2006), *Cologne, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/addcon06.

**29-2** XI Intl. Conf. on the Physics of Non-Crystalline Solids, *Rhodes, Greece*. Vasso Zatta, Institute of Materials Science, NCSR "Demokritos" 1530 10 Aghia Paraskevi Attiki, Greece; 30-210-6503381; fax 30-210-6503323; e-mail vzatta@ims.demokritos.gr; web.ims.demokritos.gr/glass/XI-PNCS.

**29-2** ▼ **Control of Particulate Processes**, *Harrison Hot Springs, BC, ECI*, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6av.html.

## NOVEMBER 2006

**8-9** ▼ **Thermoplastic Elastomers Conf.** (TPE 2006), *Munich, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/tpe06.

**12-16** **ISTFA Conf. and Exposition**, *Austin, TX*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; e-mail customer.service@asminternational.org; www.asminternational.com

**13-17** ▼ **Fuel Cell Seminar 2006**, *Honolulu, HI*. Fuel Cell Seminar Headquarters, c/o Courtesy Associates, 2025 M Street, Suite 800, Washington, DC, 20036; 202-973-8671; fax 202-331-0111; e-mail fuelcell@courtesyassoc.com; www.fuelcellseminar.com.

**27-2** **2006 MRS Fall Meeting**, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

## DECEMBER 2006

**4-5** ▼ Intl. Conf. Nanoimprint Lithography Application in Nanosystems and Nanodevices (NanoKAP 2006), *Miami Beach, FL*. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; 617-232-7400; fax 617-232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

**5-6** ▼ **Lithium Mobile Power 2006** - Conf. on Advances in Lithium Battery Technologies for Mobile Applications, *Miami Beach, FL*. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; 617-232-7400; fax 617-232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

**5-6** ▼ **RubberChem 2006**, *Munich, Germany*. Rapra Technology, 44-0-1939-250383; e-mail conferences@rapra.net; www.rapra.net/conferences/rubberchem06.

## FEBRUARY 2007

**20-23** Intl. Conf. on Recent Advances in Composite Materials (ICRACM), *New Delhi, India*. V.K. Srivastava, ICRACM-2007, Dept. of Mechanical Engineering, Institute of Technology, Banaras Hindu University, Varanasi-221005, India; 91-542-2368157; e-mail vijaysa@yahoo.com; www.htu.ac.in/notification/icracm.htm.

**25-1** **2007 TMS Annual Meeting and Exhibition**, *Orlando, FL*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/meetings/meetings.asp.

## MARCH 2007

**3-7** **Biophysical Society Annual Meeting**, *Baltimore, MD*. www.biophysics.org/meetings/future.htm.

**19-22** ▼ Intl. Laser Safety Conf. (ILSC), *San Francisco, CA*. Laser Institute of America, 13501 Ingenuity Drive, Suite 128, Orlando, FL, 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.laserinstitute.org/conferences/ilsc.

**25-29** **ACS National Meeting & Exposition**, *Chicago, IL*. American Chemical Society, attn: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; e-mail expo@acs.org; chemistry.org/expositions.

## APRIL 2007

**9-13** **2007 MRS Spring Meeting**, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

## JUNE 2007

**25-28** ▼ **ECM VIII: Bone Tissue Engineering**, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm\_meetings/next\_event.shtml.

## JULY 2007

**2-6** Intl. Congress on Glass, *Strasbourg, France*. ICG 2007, CRITT Materiaux Alsace, 19 rue de Saint Junien, BP 23, F67305 Schiltigheim Cedex, France; 33-0-3-88-19-15-10; fax 33-0-3-88-19-15-14; e-mail info@icg2007.org; www.icg2007.org.

## AUGUST 2007

**6-9** **Microscopy and Microanalysis 2007**,  *Ft. Lauderdale, FL*. Microscopy/Marketing & Education, Inc., Meeting Management Microscopy & Microanalysis, 125 Parido Street, Suite 102, Springfield, MA, 01118-2130; 972-954-8011; fax 972-954-8018; e-mail corporate@mme1.com; microscopy.org/MMMeetings.

**19-23** **ACS National Meeting and Exposition**, *Boston, MA*. American Chemical Society, ATTN: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; e-mail expo@acs.org; chemistry.org/expositions.

## OCTOBER 2007

**8-13** ▼ **Intl. Conf. on Advanced Materials (IUMRS-ICAM 2007)**, *Bangalore, India*. Secretariat IUMRS-ICAM-2007, Materials Research Society of India, Bangalore, India, 91-080-22932882; fax 91-080-23602028; e-mail secretariat@icam2007.com; www.icam2007.com. **IUMRS/MRS-I.**

## NOVEMBER 2007

**26-30** ▼ **2007 MRS Fall Meeting**, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; http://www.mrs.org. **MRS.**

## MARCH 2008

**24-28** ▼ **2008 MRS Spring Meeting**, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

## APRIL 2008

**3-9** ▼ **Experimental Biology 2008 Annual Meeting**, *San Diego, CA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

## MAY 2008

**28-1** ▼ **World Biomaterials Congress, Amsterdam, Netherlands**. Secretariat World Biomaterials Congress, International Conference Services, P.O. Box 83005, 1080 AA, Amsterdam, Netherlands, 31-0-206793218; fax 31-0-206758236; e-mail info.wbc2008@ics-online.nl; www.wbc2008.com.

## JUNE 2008

**23-26** ▼ **ECM IX Fifty Years of AO: Internal Fixation: From Research to the Clinics**, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm\_meetings/next\_event.shtml.

## DECEMBER 2008

**1-5** ▼ **2008 MRS Fall Meeting**, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.** □

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### Upcoming Meetings and Workshops from the Materials Research Society

[www.mrs.org/meetings/](http://www.mrs.org/meetings/)

Contact MRS for details.

### April 17-21, 2006

2006 MRS Spring Meeting & Exhibit  
San Francisco, CA

### May 15-18, 2006

Joint Conference—International  
Conference on New Diamond  
Science and Technology (ICNDST) and  
Applied Diamond Conference (ADC)  
Research Triangle Park, NC

### July 9-12, 2006

Organic Microelectronics Workshop II  
Toronto, Canada